

T-45-07

## CD4032A, CD4038A Types

### CMOS Triple Serial Adders

Positive Logic Adder — CD4032A

Negative Logic Adder — CD4038A

The RCA-CD4032A and CD4038A types consist of three serial adder circuits with common CLOCK and CARRY-RESET inputs. Each adder has two provisions for two serial DATA INPUT signals and an INVERT command signal. When the command signal is a logical "1", the sum is complemented. Data words enter the adder with the least significant bit first; the sign bit trails. The output is the MOD 2 sum of the input bits plus the carry from the previous bit position. The carry is only added at the positive-going clock transition for the CD4032A or at the negative-going clock for the CD4038A, thus, for spike free operation the input data transitions should occur as soon as possible after the triggering edge.

The CARRY is reset to a logical "0" at the end of each word by applying a logical "1"

#### MAXIMUM RATINGS, Absolute-Maximum Values:

STORAGE-TEMPERATURE RANGE ( $T_{stg}$ ) . . . . . -65 to +150°C

OPERATING TEMPERATURE RANGE ( $T_A$ ):

PACKAGE TYPES D, F, K, H . . . . . -65 to +125°C

PACKAGE TYPE E . . . . . -40 to +85°C

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

(Voltages referenced to  $V_{SS}$  Terminal) . . . . . -0.5 to +15 V

#### POWER DISSIPATION PER PACKAGE ( $P_D$ )

FOR  $T_A = -40$  to  $+60^\circ\text{C}$  (PACKAGE TYPE E) . . . . . 500 mW

FOR  $T_A = +60$  to  $+85^\circ\text{C}$  (PACKAGE TYPE E) . . . . . Derate Linearly at 12 mW/ $^\circ\text{C}$  to 200 mW

FOR  $T_A = -55$  to  $+100^\circ\text{C}$  (PACKAGE TYPES D, F, K) . . . . . 500 mW

FOR  $T_A = +100$  to  $+125^\circ\text{C}$  (PACKAGE TYPES D, F, K) . . . . . Derate Linearly at 12 mW/ $^\circ\text{C}$  to 200 mW

#### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (ALL PACKAGE TYPES)}$  . . . . . 100 mW

INPUT VOLTAGE RANGE, ALL INPUTS . . . . . 0.5 to  $V_{DD} + 0.5$  V

#### LEAD TEMPERATURE (DURING SOLDERING):

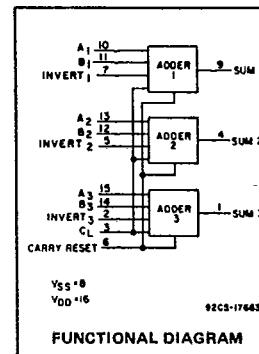
At distance  $1/16 \pm 1/32$  inch (1.59  $\pm$  0.79 mm) from case for 10 s max. . . . .  $+265^\circ\text{C}$

#### RECOMMENDED OPERATING CONDITIONS at $T_A = 25^\circ\text{C}$ , Except as Noted.

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

#### Features:

- Invert inputs on all adders for sum complementing applications
- Fully static operation . . . . . dc to 5 MHz (typ.)
- Buffered outputs
- Single-phase clocking
- Microwatt quiescent power dissipation . . . . . 5  $\mu\text{W}$  (typ.)
- Quiescent current specified to 15 V
- Maximum input leakage current of 1  $\mu\text{A}$  at 15 V (full package-temperature range)
- 1-V noise margin (full package-temperature range)
- Signal to a CARRY-RESET input one bit-position before the application of the first bit of the next word. Figs. 2 and 4 show definitive waveforms for all input and output signals.
- These types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic package (E suffix), 16-lead ceramic flat packages (K suffix), and in chip form (H suffix).



#### Applications:

- Serial arithmetic units
- Digital correlators
- Digital datalink computers
- Flight control computers
- Digital servo control systems

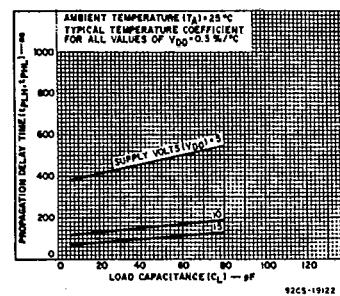


Fig. 1 — Typical propagation delay time vs. load capacitance for A, B, or INVERT inputs to sum outputs.

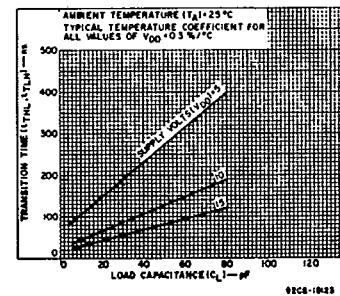


Fig. 2 — Typical transition time vs. load capacitance for sum outputs.

3875081 G E SOLID STATE

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## CD4032A, CD4038A Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20\text{ ns}$ ,  
 $C_L = 15\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS $V_{DD}$ (V)	LIMITS						UNITS	
		D, F, K, H Packages			E Package				
		Min.	Typ.	Max.	Min.	Typ.	Max.		
Propagation Delay Time; $t_{PLH}, t_{PHL}$ A, B, or Invert Inputs to Sum Outputs	5	—	400	1100	—	400	1400	ns	
	10	—	125	250	—	125	300		
Clock Input to Sum Outputs	5	—	800	2200	—	800	2400		
	10	—	250	500	—	250	600		
Transition Time; $t_{THL}, t_{TLH}$ (Sum Outputs)	5	—	125	375	—	125	425	ns	
	10	—	50	150	—	50	200		
Maximum Clock Input Frequency, $f_{CL}$	5	1.5	2.5	—	1	2.5	—	MHz	
	10	3	5	—	2	5	—		
Clock Rise & Fall Time; $t_{rCL}, t_{fCL}^{**}$	5	—	—	15	—	—	15	\mu\text{s}	
	10	—	—	15	—	—	15		
Minimum Input Set Up Time, $t_S^*$	5	—	—	$t_{rCL}$	—	—	$t_{rCL}$	ns	
	10	—	—	$t_{rCL}$	—	—	$t_{rCL}$		
Average Input Capacitance, $C_I$		—	5	—	—	5	—	pF	

\*This characteristic refers to the minimum time required for the A, B, or Reset inputs to change state following a positive clock transition (CD4032A) or negative transition (CD4038A).

\*\*If more than one unit is cascaded  $t_{rCL}$  should be made less than or equal to the sum of the transition time and the fixed propagation delay of the output of the driving stage for the estimated capacitive load.

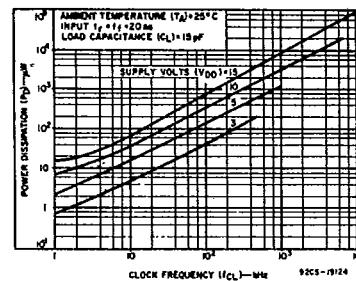


Fig. 3 - Typical dissipation characteristics.

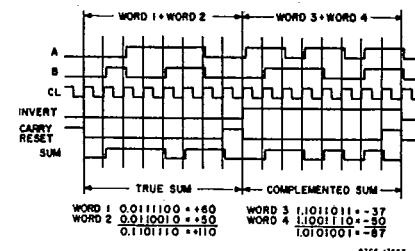


Fig. 4 - CD4032A timing diagram.

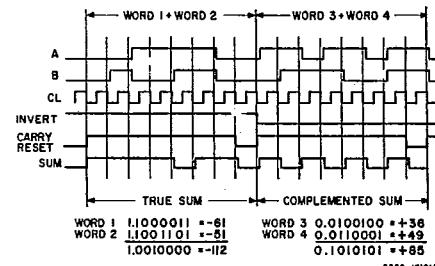


Fig. 5 - CD4038A timing diagram.

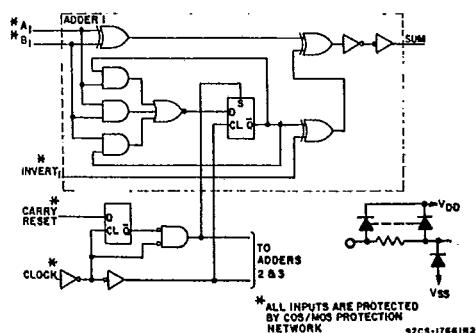


Fig. 6 - CD4032A logic diagram of one of three serial adders.

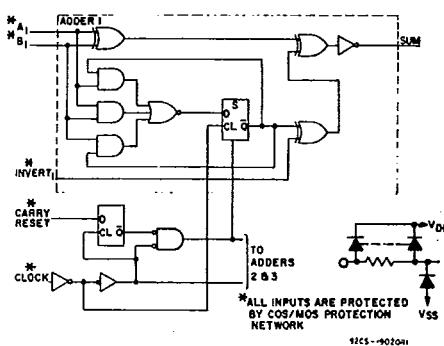


Fig. 7 - CD4038A logic diagram of one of three serial adders.

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## CD4032A, CD4038A Types

## STATIC ELECTRICAL CHARACTERISTICS

Characteristic	Conditions			Limits at Indicated Temperatures (°C)								Units	
				D, F, K, H Packages				E Package					
	$V_O$ (V)	$V_{IN}$ (V)	$V_{DD}$ (V)	-55	+25	+125	-40	+25	+85				
Quiescent Device Current $I_L$ Max.				Typ.	Limit	Typ.	Typ.	Limit	Typ.				
—	—	5	5	0.3	5	300	50	0.5	50	700	μA		
—	—	10	10	0.5	10	600	100	1	100	1400	μA		
Output Voltage: Low-Level $V_{OL}$	—	5	5	0 Typ.; 0.05 Max.								V	
	—	10	10	0 Typ.; 0.05 Max.									
High Level $V_{OH}$	—	0	5	4.95 Min.; 5 Typ.									
	—	0	10	9.95 Min.; 10 Typ.								V	
Noise Immunity: Inputs Low, $V_{NL}$	4.2	—	5	1.5 Min., 2.25 Typ.									
	9	—	10	3 Min.; 4.5 Typ.									
Inputs High, $V_{NH}$	0.8	—	5	1.5 Min.; 2.25 Typ.									
	1	—	10	3 Min.; 4.5 Typ.								V	
Noise Margin: Inputs Low, $V_{NML}$	4.5	—	5	1 Min.									
	9	—	10	1 Min.									
Inputs High, $V_{NMH}$	0.5	—	5	1 Min.									
	1	—	10	1 Min.								V	
Output Drive Current N-Channel (Sink), $I_{DN}$ Min.	0.5	—	5	0.6	0.9	0.5	0.3	0.25	0.9	0.2	0.14	mA	
	0.5	—	10	0.75	2.4	0.7	0.6	0.6	2.4	0.5	0.4		
P-Channel (Source), $I_{DP}$ Min.	4.5	—	6	-0.21	-0.4	-0.15	-0.075	-0.14	-0.4	-0.1	-0.095		
	9.5	—	10	-0.7	-7.2	-0.55	-0.35	-0.3	-1.2	-0.27	-0.22	mA	
Input Leakage Current, $I_{IL}, I_{IH}$	Any Input			$\pm 10^{-5}$ Typ., $\pm 1$ Max.									
	—	—	15	$\pm 10^{-5}$ Typ., $\pm 1$ Max.								μA	

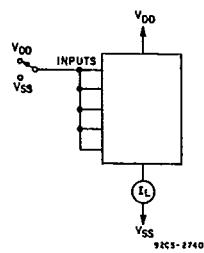


Fig. 8 — Quiescent-device-current test circuit.

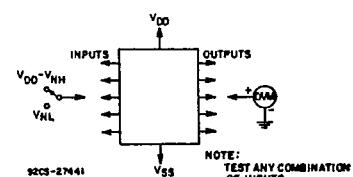


Fig. 9 — Noise-immunity test circuit.

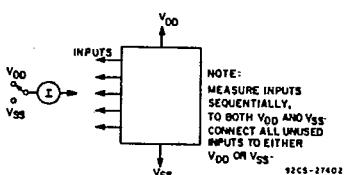
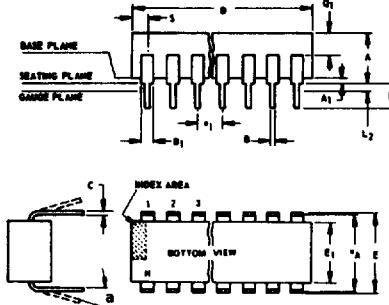


Fig. 10 — Input-leakage-current test circuit.

## Dimensional Outlines

### Dual-In-Line Welded-Seal Ceramic Packages


**NOTES:**

- Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
- When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
  - Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
  - $e_A$  applies in zone  $L_2$  when unit installed.
  - $a$  applies to spread leads prior to installation.
  - $N$  is the maximum quantity of lead positions.
  - $N_1$  is the quantity of allowable missing leads.

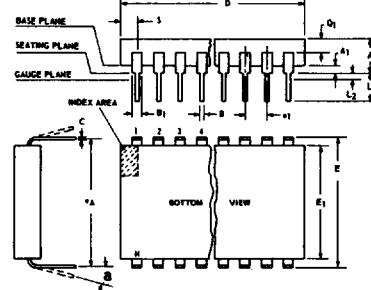
(D) SUFFIX (JEDEC MO-001-AD)  
14-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A <sub>1</sub>	0.020	0.065		0.51	1.66
B	0.014	0.020		0.366	0.508
B <sub>1</sub>	0.050	0.085		1.27	1.66
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.326		7.62	8.26
E <sub>1</sub>	0.240	0.260		6.10	6.60
$e_1$	0.100 TP		2	2.54 TP	
$e_A$	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	14		5	14	
N <sub>1</sub>	0		6	0	
$Q_1$	0.050	0.085		1.27	2.15
S	0.065	0.090		1.66	2.28

(D) SUFFIX (JEDEC MO-001-AE)  
16-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A <sub>1</sub>	0.020	0.065		0.51	1.66
B	0.014	0.020		0.366	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.66
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
$e_1$	0.100 TP		2	2.54 TP	
$e_A$	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	16		5	16	
N <sub>1</sub>	0		6	0	
$Q_1$	0.050	0.085		1.27	2.15
S	0.015	0.060		0.39	1.52

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**NOTES:**

- Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
- When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
  - Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
  - $e_A$  applies in zone  $L_2$  when unit installed.
  - $a$  applies to spread leads prior to installation.
  - $N$  is the maximum quantity of lead positions.
  - $N_1$  is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-015-AG)  
28-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5.08
A <sub>1</sub>	0.020	0.070		0.51	1.78
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.045	0.055		1.143	1.397
C	0.008	0.012	1	0.204	0.304
D	1.15	1.22		29.21	30.98
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.480	0.520		12.20	13.20
$e_1$	0.100 TP		2	2.54 TP	
$e_A$	0.600 TP		2, 3	15.24 TP	
L	0.100	0.180		2.54	4.57
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24		5	24	
N <sub>1</sub>	0		6	0	
$Q_1$	0.020	0.080		0.51	2.03
S	0.020	0.060		0.51	1.52

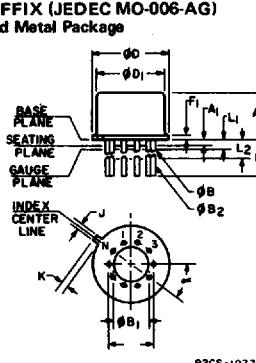
(D) SUFFIX (JEDEC MO-015-AH)  
28-Lead Dual-In-Line Welded-Seal  
Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5
A <sub>1</sub>	0	0.070	2	0	1.77
B	0.015	0.020		0.381	0.508
B <sub>1</sub>	0.015	0.055		0.39	1.39
C	0.008	0.012	1	0.204	0.304
D	1.380	1.420		35.06	36.06
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.485	0.515		12.32	13.08
$e_1$	0.100 TP		2	2.54 TP	
$e_A$	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.8	5
L <sub>2</sub>	0	0.030		0	0.76
a	0°	15°	4	0°	15°
N	28		5	28	
N <sub>1</sub>	0		6	0	
$Q_1$	0.020	0.070		0.51	1.77
S	0.040	0.070		1.02	1.77

92CM-20250R2

### TO-5 Style Package

(T) SUFFIX (JEDEC MO-006-AG)  
12-Lead Metal Package



92CS-19774

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
a	0.230		2	5.84	TP
A <sub>1</sub>	0	0		0	0
A <sub>2</sub>	0.165	0.185		4.19	4.70
$\phi_B$	0.016	0.019	3	0.407	0.482
$\phi B_1$	0	0		0	0
$\phi B_2$	0.016	0.021	3	0.407	0.533
$\phi D$	0.335	0.370		8.51	9.39
$\phi D_1$	0.306	0.335		7.75	8.60
F <sub>1</sub>	0.020	0.040		0.51	1.01
j	0.028	0.034		0.712	0.863
k	0.029	0.045	4	0.74	1.14
L <sub>1</sub>	0.000	0.050	3	0.00	1.27
L <sub>2</sub>	0.250	0.500	3	6.4	12.7
L <sub>3</sub>	0.500	0.562	3	12.7	14.27
$\alpha$	30° TP			30° TP	
N	12		6	12	
N <sub>1</sub>	1		5	1	

**NOTES:**

- Refer to Rules for Dimensioning Axial Lead Product Outlines.
- Leads at gauge plane within 0.007" (0.178 mm) radius of True Position (TP) at maximum material condition.
- $\phi B$  applies between L<sub>1</sub> and L<sub>2</sub>.  $\phi B_2$  applies between seating plane and L<sub>2</sub>. Diameter is uncontrolled in L<sub>1</sub> and beyond L<sub>2</sub>.
- Measure from Max.  $\phi D$ .
- $N_1$  is the quantity of allowable missing leads.
- $N$  is the maximum quantity of lead positions.

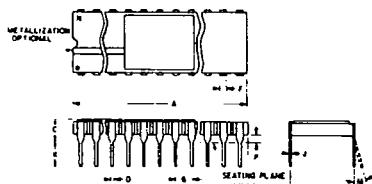
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## Dimensional Outlines (Cont'd)

## DUAL-IN-LINE SIDE-BRAZED CERAMIC PACKAGES



(D) SUFFIX  
18-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.890	0.915		22.606	23.241
C	—	0.200		—	5.080
D	0.015	0.021		0.381	0.533
F	0.054	REF.	1	1.371	REF.
G	0.100	BSC	1	2.54	BSC
H	0.035	0.065		0.889	1.651
J	0.008	0.012	3	0.203	0.304
K	0.125	0.150		3.175	3.810
L	0.290	0.310	2	7.366	7.874
M	0°	15°		0°	15°
P	0.025	0.045		0.635	1.143
N	18			18	

92CS-27231R1

(D) SUFFIX  
22-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.065	1.100		27.05	27.94
C	0.085	0.145		2.16	3.68
D	0.017	0.023		0.43	0.58
F	0.040	REF.	1	1.02	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.380	0.420	2	9.65	10.67
M	—	7°		—	7°
P	0.025	0.060		0.64	1.27
N	22			22	

92CS-25186R2

(D) SUFFIX  
24-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.180	1.220		29.98	30.98
C	0.085	0.145		2.16	3.68
D	0.015	0.023		0.39	0.58
F	0.040	REF.		1.02	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.77	1.77
J	0.008	0.012	3	0.21	0.30
K	0.125	0.175		3.18	4.44
L	0.580	0.620	2	14.74	15.74
M	—	7°		—	7°
P	0.025	0.050		0.64	1.27
N	24			24	

92CS-30986R1

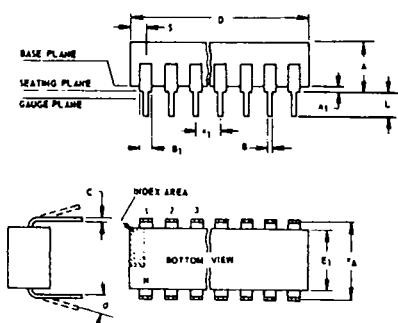
(D) SUFFIX  
40-Lead Dual-In-Line  
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.980	2.020		50.30	51.30
C	0.095	0.155		2.43	3.93
D	0.017	0.023		0.43	0.56
F	0.050	REF.		1.27	REF.
G	0.100	BSC	1	2.54	BSC
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.580	0.620	2	14.74	15.74
M	—	7°		—	7°
P	0.025	0.060		0.64	1.27
N	40			40	

92CM-27029R2

## Dual-In-Line Plastic and Frit-Seal Ceramic Packages

(E) SUFFIX (JEDEC MO-001-AN)  
8-Lead Dual-In-Line Plastic  
(Mini-DIP) Package



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.889	1.65
C	0.008	0.012	1	0.203	0.304
D	0.370	0.400		9.40	10.16
E	0.300	0.326		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
B <sub>1</sub>	0.100 TP		2	2.54 TP	
B <sub>A</sub>	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.762
a	0	15	4	0	15
N	8		5	8	
N <sub>1</sub>	0		6	0	
O <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.015	0.060		0.381	1.52

92CS-24026R1

## NOTES:

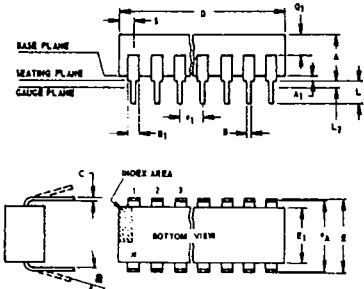
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.

- When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
- Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
- $a_A$  applies in zone L<sub>2</sub> when unit installed.
- $a$  applies to spread leads prior to installation.
- N is the maximum quantity of lead positions.
- N<sub>1</sub> is the quantity of allowable missing leads.

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**Dimensional Outlines (Cont'd)****Dual-In-Line Plastic and Frit-Seal Ceramic Packages (Cont'd)**

## NOTES:

- Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
- When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
  - Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
  - $\alpha_A$  applies in zone  $L_2$  when unit installed.
  - $\alpha$  applies to spread leads prior to installation.
  - $N$  is the maximum quantity of lead positions.
  - $N_1$  is the quantity of allowable missing leads.

(E) and (F) SUFFIXES (JEDEC MO-001-AB)  
16-Lead Dual-In-Line Plastic or  
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.166	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
$\epsilon_1$	0.100 TP		2	2.54 TP	
$\epsilon_A$	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.78
a	0°	15°	4	0°	15°
N	14		5	14	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.065	0.090		1.66	2.28

92SS-4296R3

(E) and (F) SUFFIXES (JEDEC MO-001-AC)  
16-Lead Dual-In-Line Plastic or  
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.166	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E <sub>1</sub>	0.240	0.260		6.10	6.60
$\epsilon_1$	0.100 TP		2	2.54 TP	
$\epsilon_A$	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0.000	0.030		0.000	0.78
a	0°	15°	4	0°	15°
N	18		5	18	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.065	0.090		1.66	2.28

92CM-1596R4

(E) SUFFIXX  
22-Lead Dual-In-Line  
Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A <sub>1</sub>	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B <sub>1</sub>	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.845	0.885		21.47	22.47
E <sub>1</sub>	0.240	0.260		6.10	6.60
$\epsilon_1$	0.100 TP		2	2.54 TP	
$\epsilon_A$	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L <sub>2</sub>	0	0.030		0	0.762
a	0°	15°	4	0°	15°
N	18		5	18	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.015	0.060		0.39	1.52

92CS-30830

(E) and (F) SUFFIXES (JEDEC MO-015-AA)  
24-Lead Dual-In-Line Plastic or  
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A <sub>1</sub>	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B <sub>1</sub>	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	1.20	1.29		30.48	32.76
E	0.600	0.625		15.24	15.87
E <sub>1</sub>	0.515	0.580		13.09	14.73
$\epsilon_1$	0.100 TP		2	2.54 TP	
$\epsilon_A$	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.54	5.00
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24		5	24	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.040	0.075		1.02	1.90
S	0.040	0.100		1.02	2.54

92CS26938R2

(E) SUFFIXX  
40-Lead Dual-In-Line  
Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A <sub>1</sub>	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B <sub>1</sub>	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	2.000	2.090		50.80	53.09
E <sub>1</sub>	0.515	0.580		13.09	14.73
$\epsilon_1$	0.100 TP		2	2.54 TP	
$\epsilon_A$	0.600 TP		2, 3	15.24 TP	
L	0.100	0.200		2.54	5.00
L <sub>2</sub>	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	40		5	40	
N <sub>1</sub>	0		6	0	
Q <sub>1</sub>	0.065	0.095		1.66	2.41
S	0.040	0.100		1.02	2.54

92CS-30959

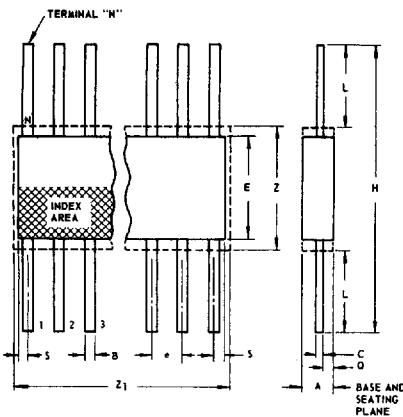
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## Dimensional Outlines (Cont'd)

## Ceramic Flat Packs

## (K) SUFFIX (JEDEC MO-004-AF)

14-Lead



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006		0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	14		3		14
Q	0.005	0.050		0.13	1.27
S	0.000	0.050		0.00	1.27
Z	0.300		4	7.62	
Z <sub>1</sub>	0.400		4	10.16	

92SS-4300R3

## NOTES:

- Refer to JEDEC Publication No. 95 for Rules for Dimensioning Peripheral Lead Outlines.
- Leads within 0.005" (0.12 mm) radius of True Position (TP) at maximum material condition.
- N is the maximum quantity of lead positions.
- Z and Z<sub>1</sub> determine a zone within which all body and lead irregularities lie.

## (K) SUFFIX (JEDEC MO-004-AG)

16-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006		0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	16		3	16	
Q	0.005	0.050		0.13	1.27
S	0.000	0.025		0.00	0.63
Z	0.300		4	7.62	
Z <sub>1</sub>	0.400		4	10.16	

92CS-1727IR3

(K) SUFFIX  
24-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	24		3	24	
Q	0.035	0.070		0.89	1.77
S	0.060	0.110	1	1.53	2.79
Z	0.700		4	17.78	
Z <sub>1</sub>	0.750		4	19.05	

92CS-1994R2

(K) SUFFIX  
28-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	28		3	28	
Q	0.035	0.070		0.89	1.77
S	0	0.060	1	0	1.53
Z	0.700		4	17.78	
Z <sub>1</sub>	0.750		4	19.05	

92CS-20972